設備名稱: 充電基座 · 型號(型式):(Equipment name Type designation (Type)						CT40-EB
單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁺⁶)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
印刷電路部件 (PCBA)	-	0	0	0	0	0
上蓋(Top Cover)	0	0	0	0	0	0
下蓋(Bottom Cover)	0	0	0	0	0	0
連接線 (Cable)	0	0	0	0	0	0
電源供應器 (Power Supply)	-	0	0	0	0	0

備考1. "超出0.1 wt %"及"超出0.01 wt %" 係指限用物質之百分比含量超出百分比含量基準

Note 1: "Exceeding 0.1 wt %" and "exceeding 0.01 wt %" indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. "〇" 係指該項限用物質之百分比含量未超出百分比含量基準值。
Note 2:"〇" indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. ¯ - ″ 係指該項限用物質為排除項目。 Note 3: The "-" indicates that the restricted substance corresponds to the exemption.